

## US00D328074S

# United States Patent [19]

# Yamazaki et al.

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# **HEADPHONE** [54] Akira Yamazaki, Saitama; Ohshi Inventors: Miyashita, Tokyo, both of Japan [73] Assignee: Sony Corporation, Tokyo, Japan Term: 14 Years Appl. No.: 651,904 [22] Filed: Feb. 7, 1991 [30] Foreign Application Priority Data Aug. 7, 1990 [JP] Japan ...... 2-26721 [58] D14/223, 299, 220; 381/25, 158, 183, 189, 58; 379/40, 444; 181/129 [56] References Cited U.S. PATENT DOCUMENTS

### OTHER PUBLICATIONS

High Fidelity Magazine, Sep. 1987, p. 9, "Sony" Head-phones.

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[57]

#### **CLAIM**

The ornamental design for a headphone, as shown and described.

### **DESCRIPTION**

FIG. 1 is a top, front and right-side perspective view of a headphone, showing our new design;

FIG. 2 is a top, front and right-side perspective view thereof, shown with head band in the expanded position;

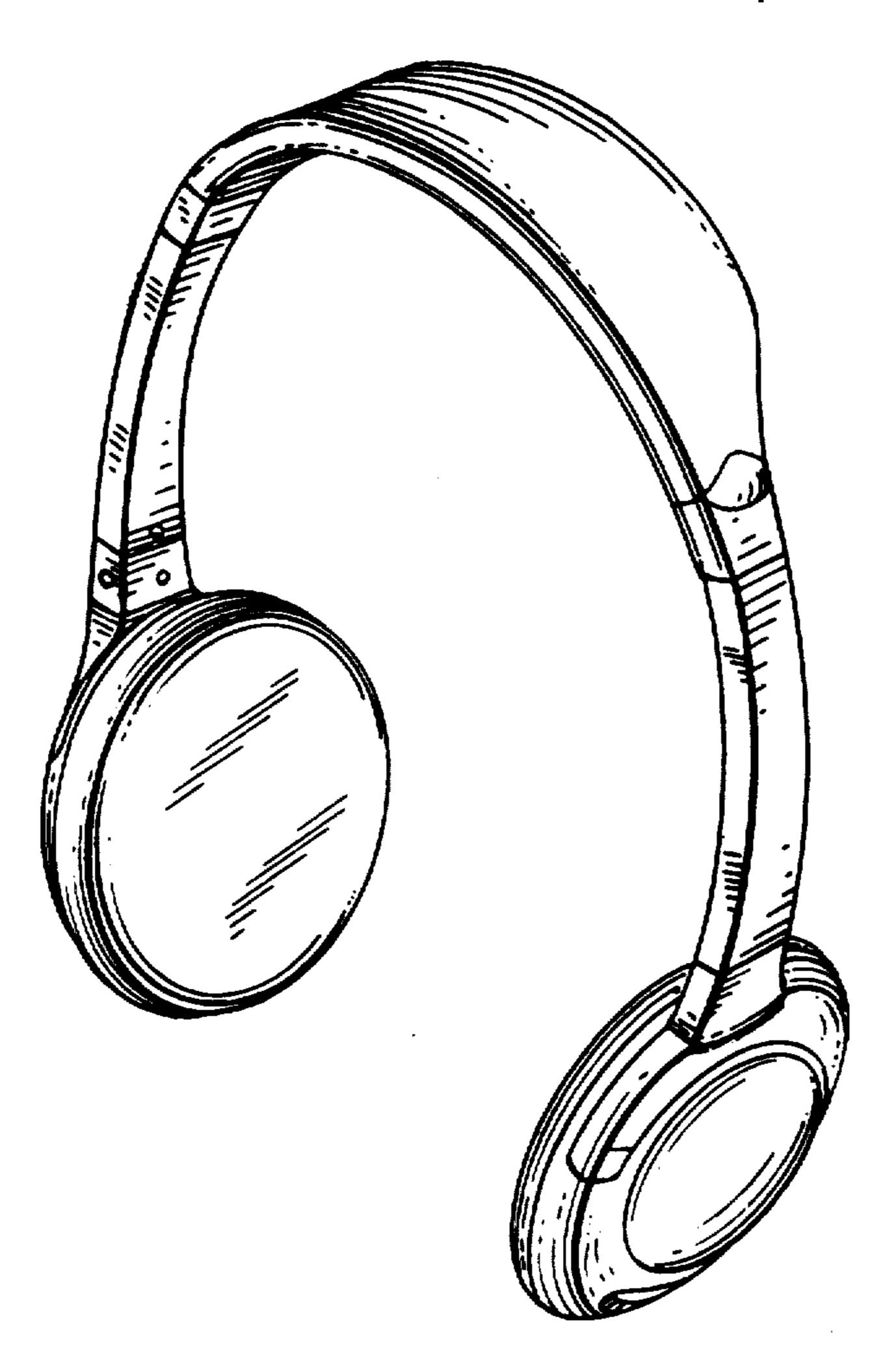
FIG. 3 is a front elevational view thereof;

FIG. 4 is a rear elevational view thereof;

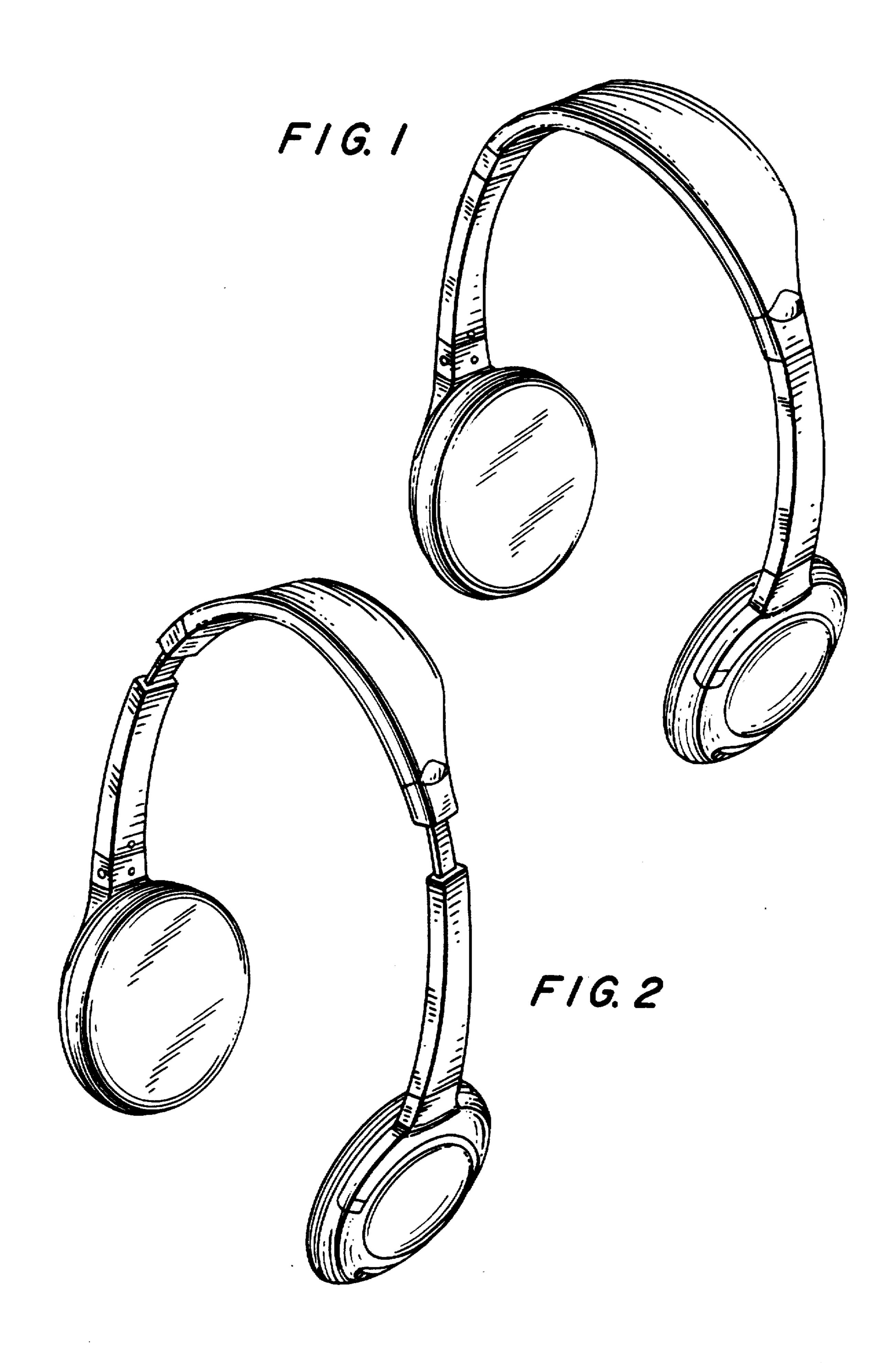
FIG. 5 is a right-side elevational view thereof, the left-side being a mirror image;

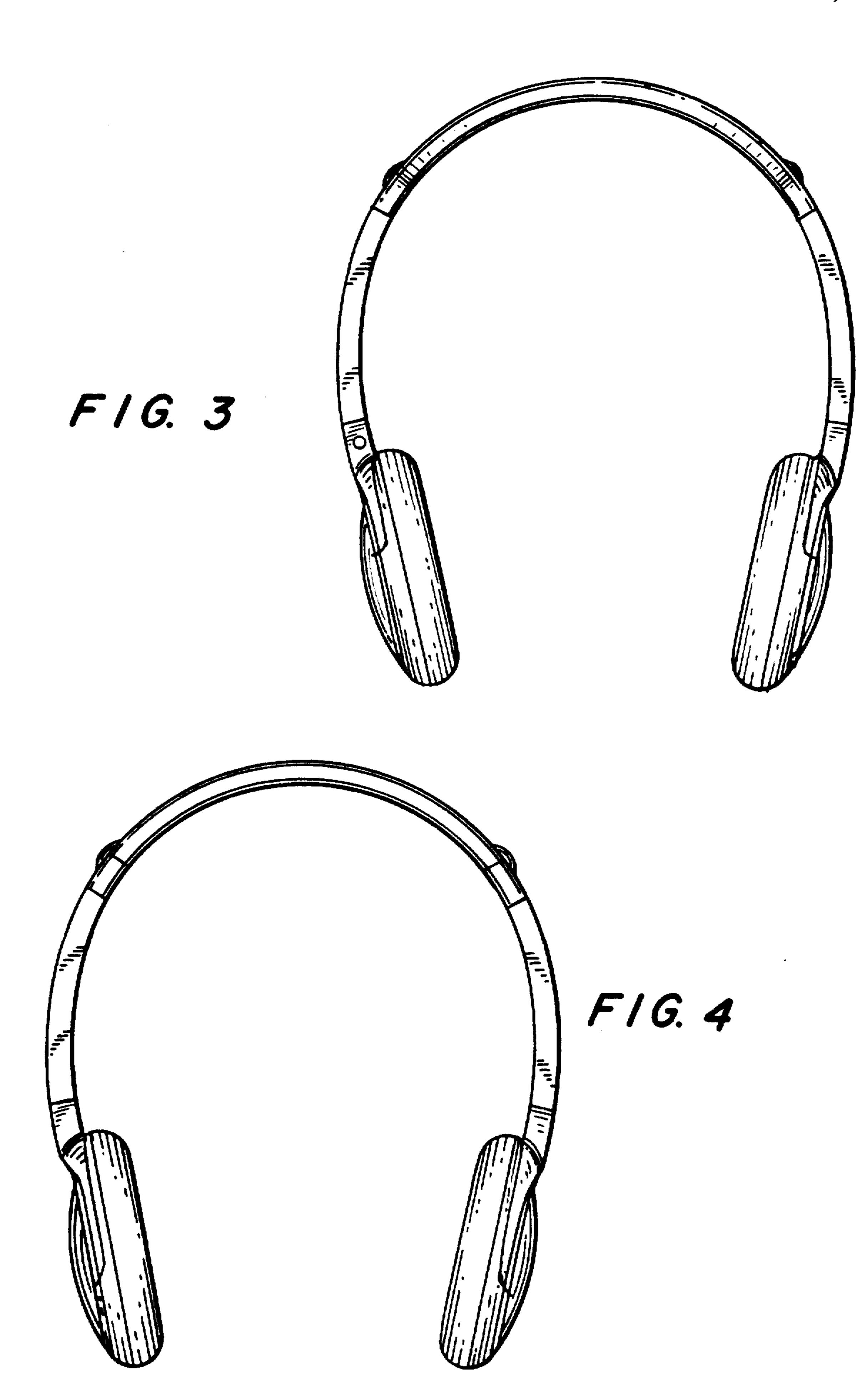
FIG. 6 is a top plan view thereof; and,

FIG. 7 is a bottom plan view thereof.

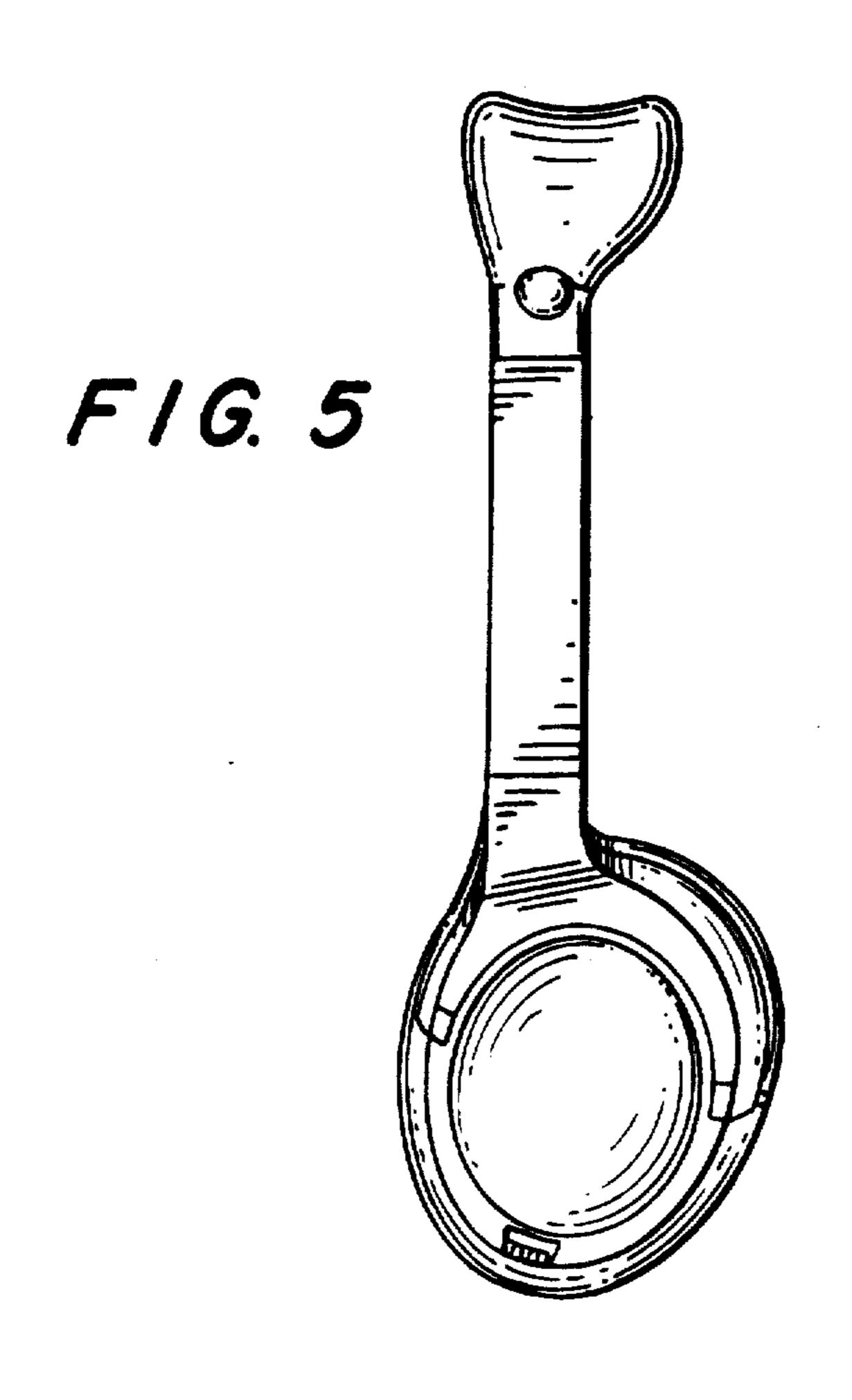


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